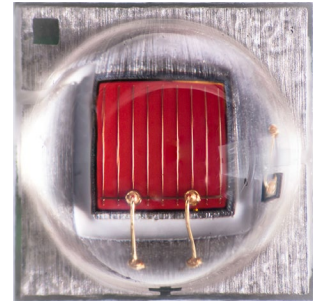
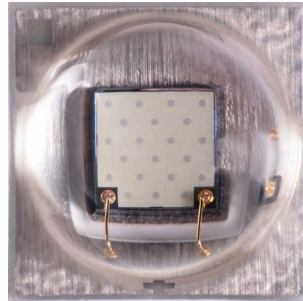
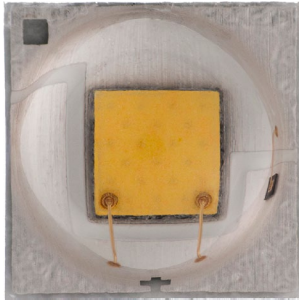


Cree® XLamp® XP-E2 LEDs



PRODUCT DESCRIPTION

The XLamp® XP-E2 LED builds on the unprecedented performance of the original XP-E by increasing lumen output up to 20% while providing a single die LED point source for precise optical control. The XP-E2 LED shares the same footprint as the original XP-E, providing a seamless upgrade path to more lumens and/or greater efficiency while shortening the design cycle for existing XP customers.

XLamp XP-E2 LEDs are the ideal choice for lighting applications where high light output and maximum efficacy are required, such as LED retrofit lamps, outdoor, portable, indoor directional, emergency vehicle or architectural.

FEATURES

- Available in white, outdoor white, 80-CRI, 85-CRI, 90-CRI white, royal blue, blue, green, PC amber, amber, red-orange & red
- ANSI-compatible chromaticity bins
- White binned at 85 °C
- Maximum drive current: 1 A
- Low thermal resistance: as low as 5 °C/W
- Wide viewing angle: 110°-135°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable - JEDEC J-STD-020C compatible
- Electrically neutral thermal path
- RoHS-compliant
- UL-recognized component (E349212)

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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		9	
Thermal resistance, junction to solder point - green	°C/W		15	
Thermal resistance, junction to solder point - PC amber	°C/W		9	
Thermal resistance, junction to solder point - amber	°C/W		7	
Thermal resistance, junction to solder point - red-orange, red	°C/W		5	
Viewing angle (FWHM) - white	degrees		110	
Viewing angle (FWHM) - royal blue, blue, green	degrees		135	
Viewing angle (FWHM) - PC amber	degrees		110	
Viewing angle (FWHM) - amber, red-orange, red	degrees		130	
Temperature coefficient of voltage - white	mV/°C		-2.3	
Temperature coefficient of voltage - royal blue, blue	mV/°C		-3.3	
Temperature coefficient of voltage - green	mV/°C		-3.8	
Temperature coefficient of voltage - PC amber	mV/°C		-2.5	
Temperature coefficient of voltage - amber, red-orange, red	mV/°C		-1.8	
ESD withstand voltage (HBM per Mil-Std-883D)- white, royal blue, blue, green	V			8000
ESD classification (HBM per Mil-Std-883D) - PC amber, amber, red-orange, red			Class 2	
DC forward current	mA			1000
Reverse voltage	V			5
Forward voltage (@ 350 mA, 85 °C) - white	V		2.9	3.25
Forward voltage (@ 700 mA, 85 °C) - white			3.05	
Forward voltage (@ 1000 mA, 85 °C) - white			3.15	
Forward voltage (@ 350 mA, 25 °C) - royal blue, blue	V		3.1	3.5
Forward voltage (@ 1000 mA, 25 °C) - royal blue, blue	V		3.4	
Forward voltage (@ 350 mA, 25 °C) - green	V		3.2	3.8
Forward voltage (@ 1000 mA, 25 °C) - green	V		3.7	
Forward voltage (@ 350 mA, 25 °C) - PC amber	V		3.05	3.5
Forward voltage (@ 1000 mA, 25 °C) - PC amber	V		3.28	
Forward voltage (@ 350 mA, 25 °C) - amber, red-orange, red	V		2.2	2.6
Forward voltage (@ 1000 mA, 25 °C) - amber, red-orange, red	V		2.65	
LED junction temperature	°C			150

FLUX CHARACTERISTICS (T_j = 85 °C) - WHITE

The following table provides several base order codes for XLamp XP-E2 LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP Family LEDs Binning and Labeling document.

Color	CCT Range		Base Order Codes Min. Luminous Flux (lm) @ 350 mA			Calculated Minimum Luminous Flux (lm)** @ 85 °C		Order Code
	Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1.0 A	
Cool White	5000 K	10,000 K	Q4	100	116	171	218	XPEBWT-L1-0000-00C51
			Q5	107	124	183	233	XPEBWT-L1-0000-00D51
			R2	114	132	195	249	XPEBWT-L1-0000-00E51
			R3	122	142	209	266	XPEBWT-L1-0000-00F51
Outdoor White	4000 K	5300 K	Q4	100	116	171	218	XPEBWT-01-0000-00CC2
			Q5	107	124	183	233	XPEBWT-01-0000-00DC2
			R2	114	132	195	249	XPEBWT-01-0000-00EC2
			R3	122	142	209	266	XPEBWT-01-0000-00FC2
Neutral White	3700 K	5300 K	Q4	100	116	171	218	XPEBWT-L1-0000-00CE4
			Q5	107	124	183	233	XPEBWT-L1-0000-00DE4
			R2	114	132	195	249	XPEBWT-L1-0000-00EE4
80-CRI White	2200 K	4300 K	Q2	87.4	101	150	191	XPEBWT-H1-0000-00AE7
			Q3	93.9	109	161	205	XPEBWT-H1-0000-00BE7
Warm White	2200 K	3700 K	Q2	87.4	101	150	191	XPEBWT-L1-0000-00AE7
			Q3	93.9	109	161	205	XPEBWT-L1-0000-00BE7
			Q4	100	116	171	218	XPEBWT-L1-0000-00CE7
85-CRI White	2600 K	3200 K	P2	67.2	78.0	115	147	XPEBWT-P1-0000-007E7
			P3	73.9	85.7	127	161	XPEBWT-P1-0000-008E7
			P4	80.6	93.5	138	176	XPEBWT-P1-0000-009E7
			Q2	87.4	101	150	191	XPEBWT-P1-0000-00AE7
90-CRI White	2600 K	3200 K	P2	67.2	78.0	115	147	XPEBWT-U1-0000-007E7
			P3	73.9	85.7	127	161	XPEBWT-U1-0000-008E7
			P4	80.6	93.5	138	176	XPEBWT-U1-0000-009E7

Notes:

- Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements, ± 0.005 on chromaticity (CCx, CCy) measurements and ± 2 on CRI measurements.
- Typical CRI for Cool White (5000 K – 10,000 K CCT) is 70.
- Typical CRI for Neutral White (3700 K – 5300 K CCT) is 75.
- Typical CRI for Outdoor White (4000 K - 5300 K CCT) is 70.
- Typical CRI for Warm White (2200 K – 3700 K CCT) is 80.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.
- * Flux values @ 25 °C are calculated and for reference only.
- ** Calculated flux values at 700 mA and 1 A are for reference only.

FLUX CHARACTERISTICS ($T_j = 25\text{ }^{\circ}\text{C}$) - COLOR

The following table provides several base order codes for XLamp XP-E2 color LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP Family LEDs Binning and Labeling document.

Color	Minimum Radiant Flux @ 350 mA		Dominant Wavelength Range				Order Codes,
	Group	Flux (mW)	Min.		Max.		
			Group	DWL (nm)	Group	DWL (nm)	
Royal Blue	30	450	D3	450	D5	465	XPEBRY-L1-0000-00J01
	31	475	D3	450	D5	465	XPEBRY-L1-0000-00K01
	32	500	D3	450	D5	465	XPEBRY-L1-0000-00L01
	33	525	D3	450	D5	465	XPEBRY-L1-0000-00M01
	34	550	D3	450	D5	465	XPEBRY-L1-0000-00N01
	35	575	D3	450	D5	465	XPEBRY-L1-0000-00P01

Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm) @ 350 mA		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Blue	B3	465	B6	485	K2	30.6	XPEBBL-L1-0000-00Y01
					K3	35.2	XPEBBL-L1-0000-00Z01
					M2	39.8	XPEBBL-L1-0000-00201
					M3	45.7	XPEBBL-L1-0000-00301

Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm) @ 350 mA		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Green	G2	520	G4	535	Q2	87.4	XPEBGR-L1-0000-00A01
					Q3	93.9	XPEBGR-L1-0000-00B01
					Q4	100	XPEBGR-L1-0000-00C01
					Q5	107	XPEBGR-L1-0000-00D01
					R2	114	XPEBGR-L1-0000-00E01
					R3	122	XPEBGR-L1-0000-00F01

Note:

- Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements and $\pm 1\text{ nm}$ on dominant wavelength measurements.

FLUX CHARACTERISTICS (T_j = 25 °C) - COLOR (CONTINUED)

Color	Color Bin	Base Order Codes Min. Luminous Flux (lm) @ 350 mA		Order Code
		Group	Flux (lm)	
PC Amber	Y2	Q2	87.4	XPEBPA-L1-0000-00A01
		Q3	93.9	XPEBPA-L1-0000-00B01
		Q4	100	XPEBPA-L1-0000-00C01

Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm) @ 350 mA		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Amber	A2	585	A3	595	N4	62.0	XPEBAM-L1-0000-00601
					P2	67.2	XPEBAM-L1-0000-00701
					P3	73.9	XPEBAM-L1-0000-00801
					P4	80.6	XPEBAM-L1-0000-00901

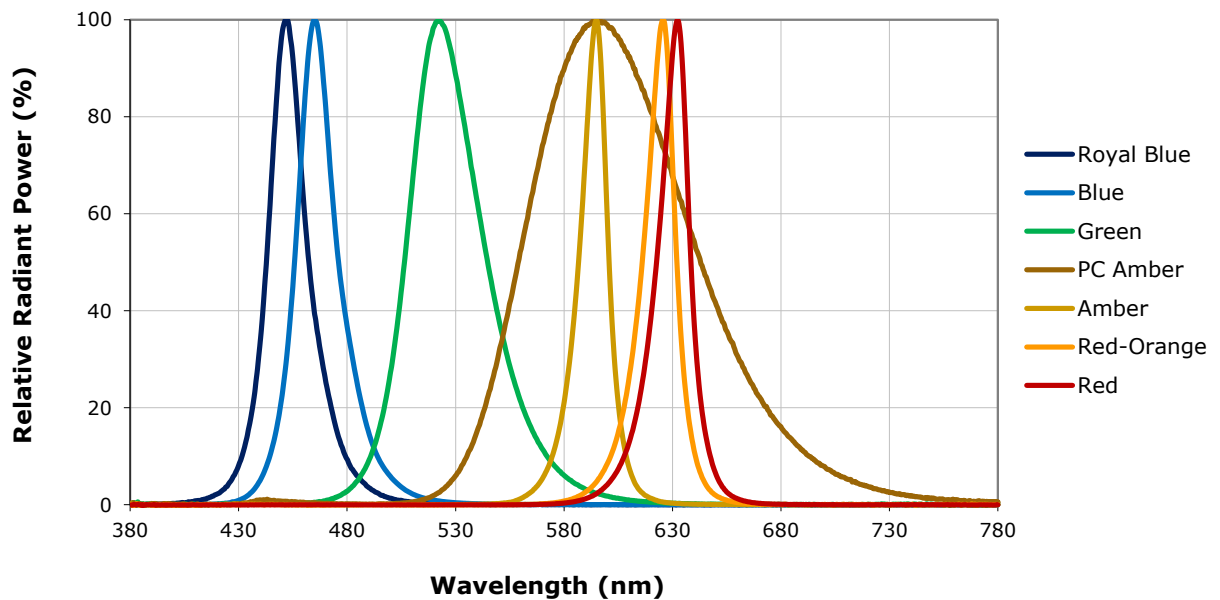
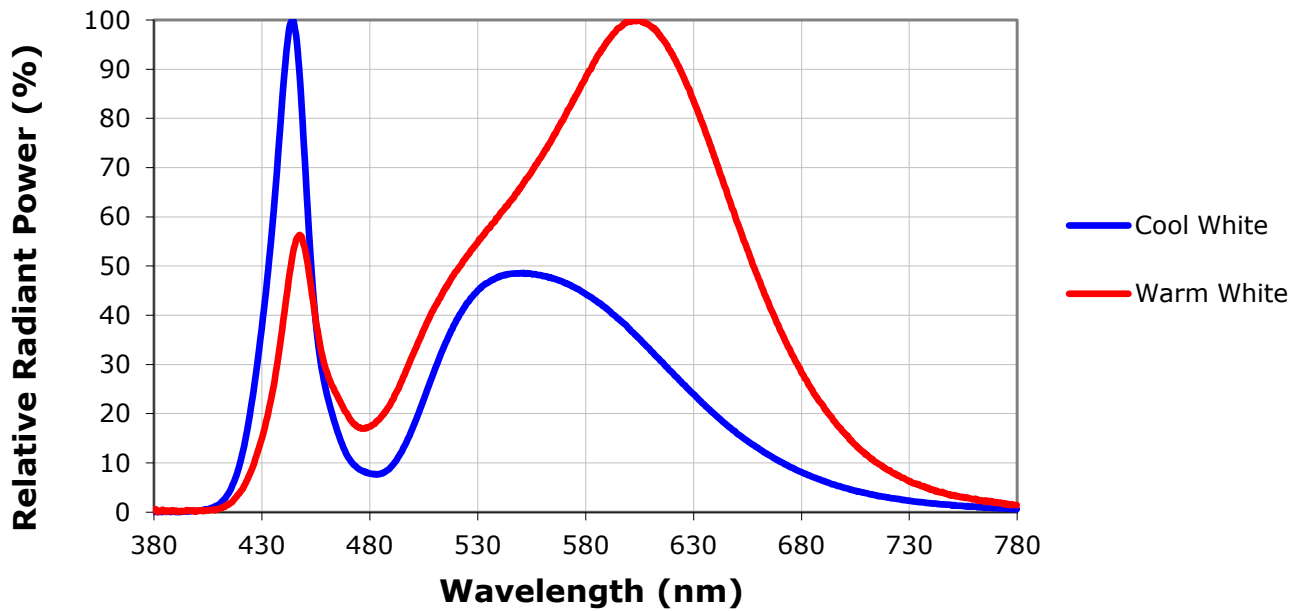
Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm) @ 350 mA		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Red-Orange	O3	610	O4	620	P2	67.2	XPEBRO-L1-0000-00701
					P3	73.9	XPEBRO-L1-0000-00801
					P4	80.6	XPEBRO-L1-0000-00901
					Q2	87.4	XPEBRO-L1-0000-00A01
					Q3	93.9	XPEBRO-L1-0000-00B01
					Q4	100	XPEBRO-L1-0000-00C01

Color	Dominant Wavelength Range				Base Order Codes Min. Luminous Flux (lm) @ 350 mA		Order Code
	Min.		Max.				
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Red	R2	620	R3	630	N3	56.8	XPEBRD-L1-0000-00501
					N4	62.0	XPEBRD-L1-0000-00601
					P2	67.2	XPEBRD-L1-0000-00701
					P3	73.9	XPEBRD-L1-0000-00801

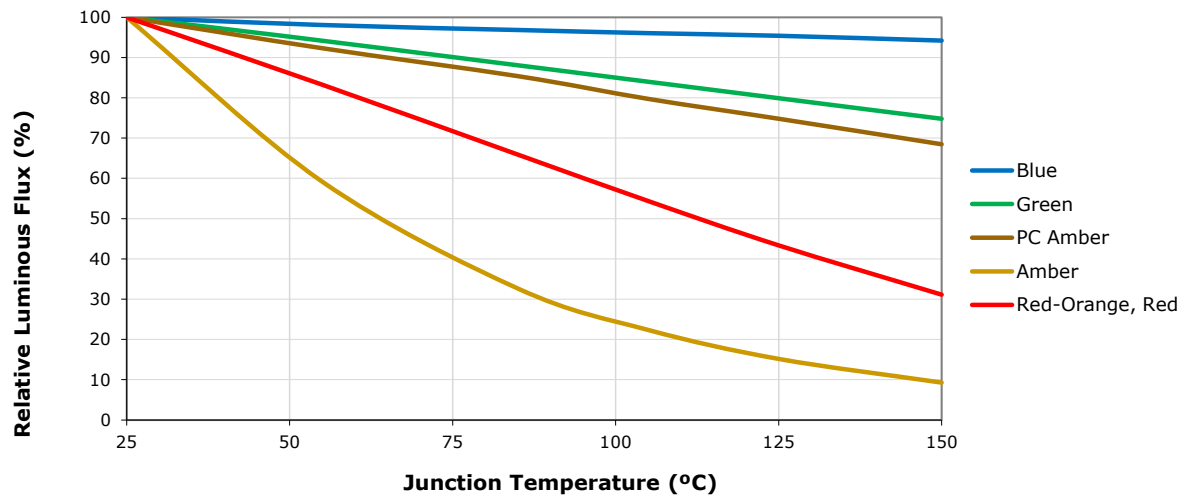
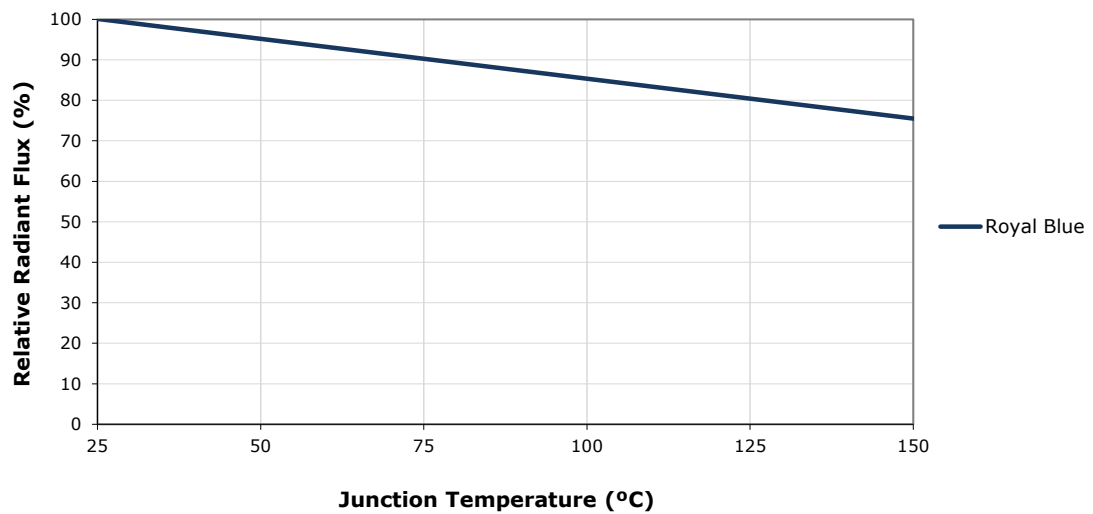
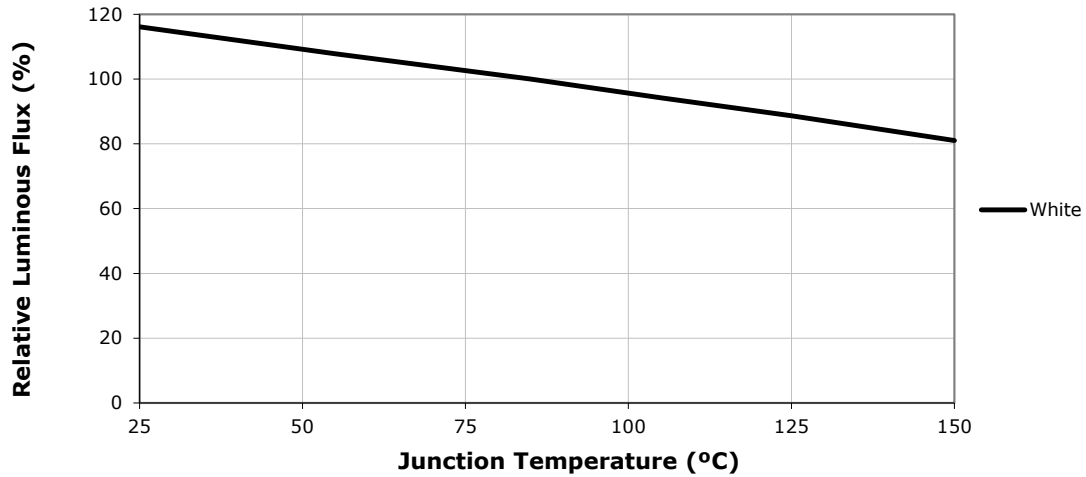
Note:

- Cree maintains a tolerance of ± 7% on flux and power measurements and ± 1 nm on dominant wavelength measurements.

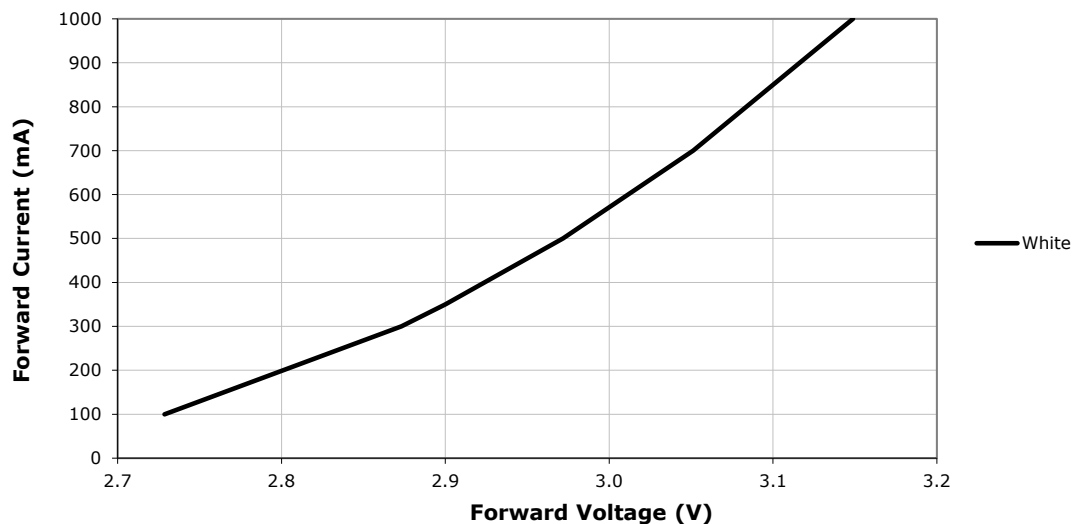
RELATIVE SPECTRAL POWER DISTRIBUTION



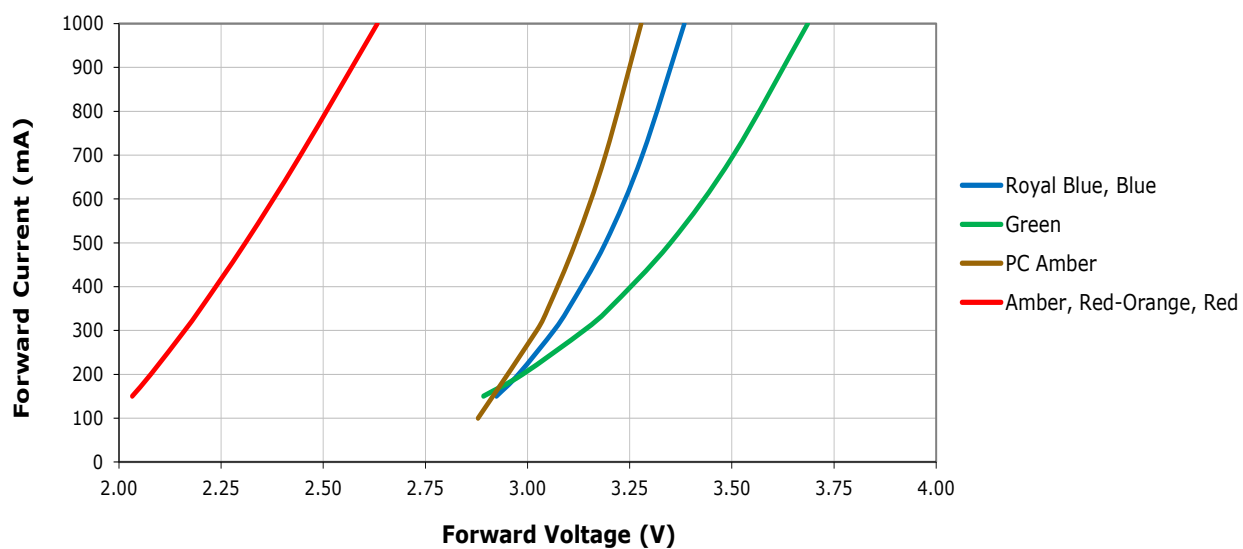
RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 350$ mA)



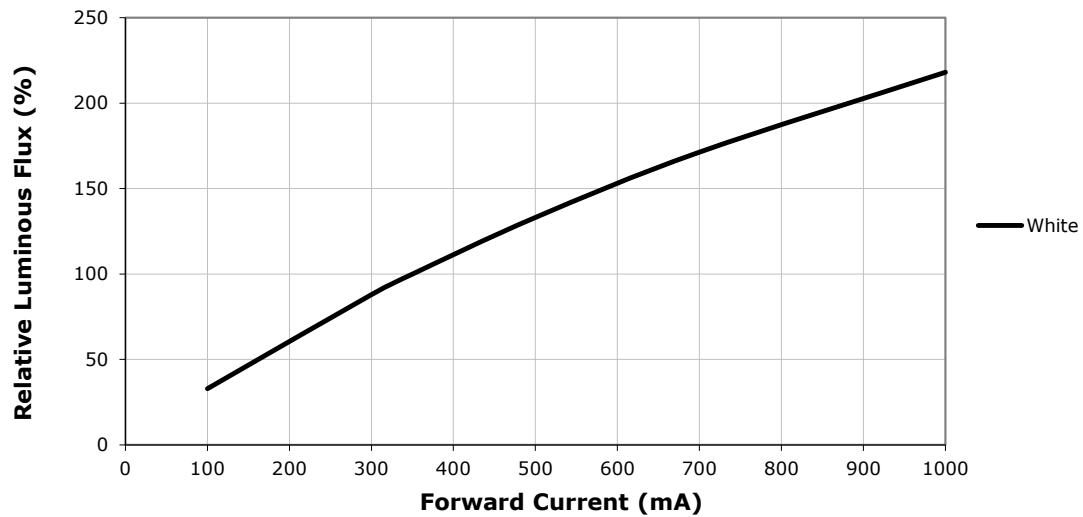
ELECTRICAL CHARACTERISTICS ($T_j = 85\text{ }^{\circ}\text{C}$) - WHITE



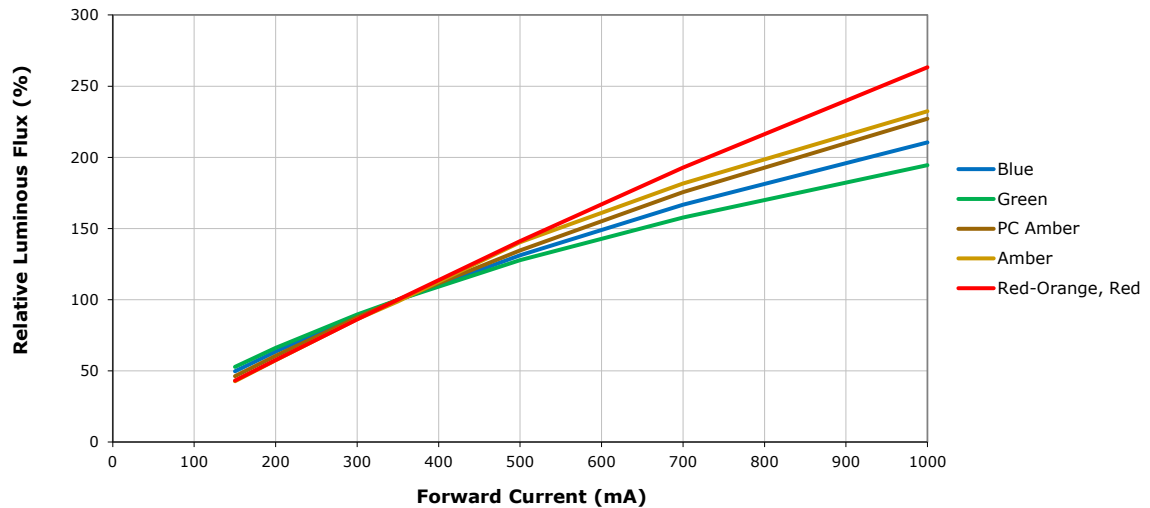
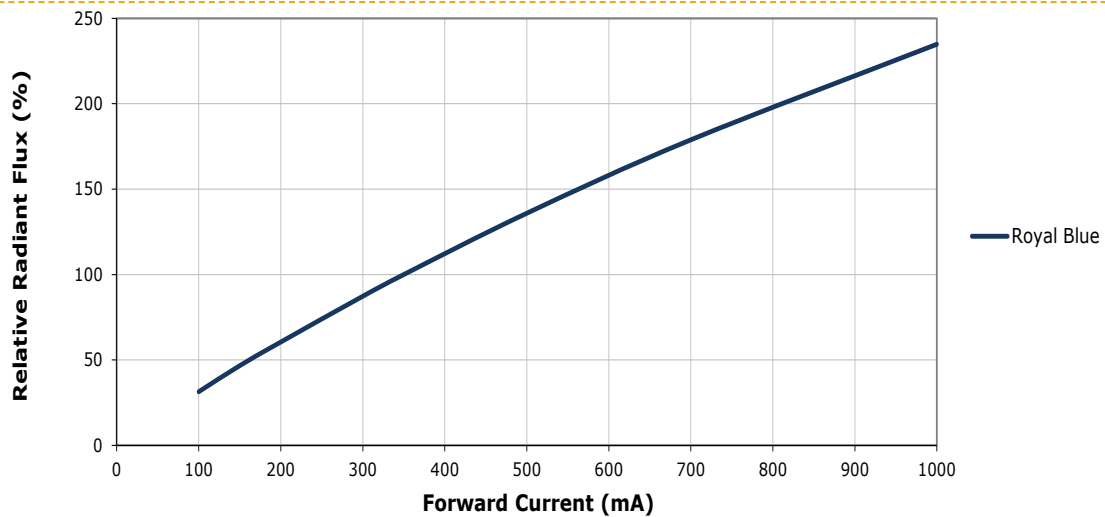
ELECTRICAL CHARACTERISTICS ($T_j = 25\text{ }^{\circ}\text{C}$) - COLOR



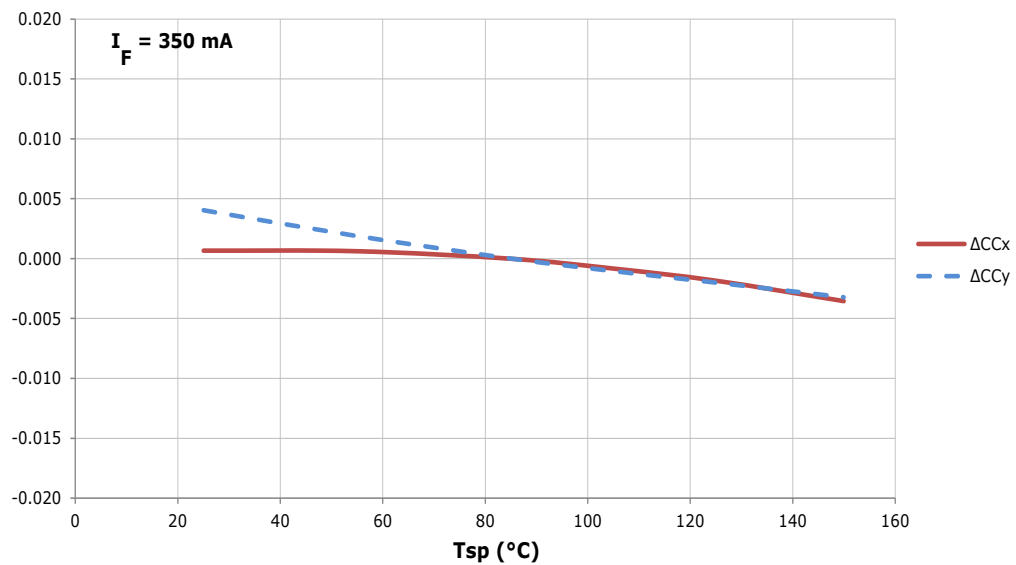
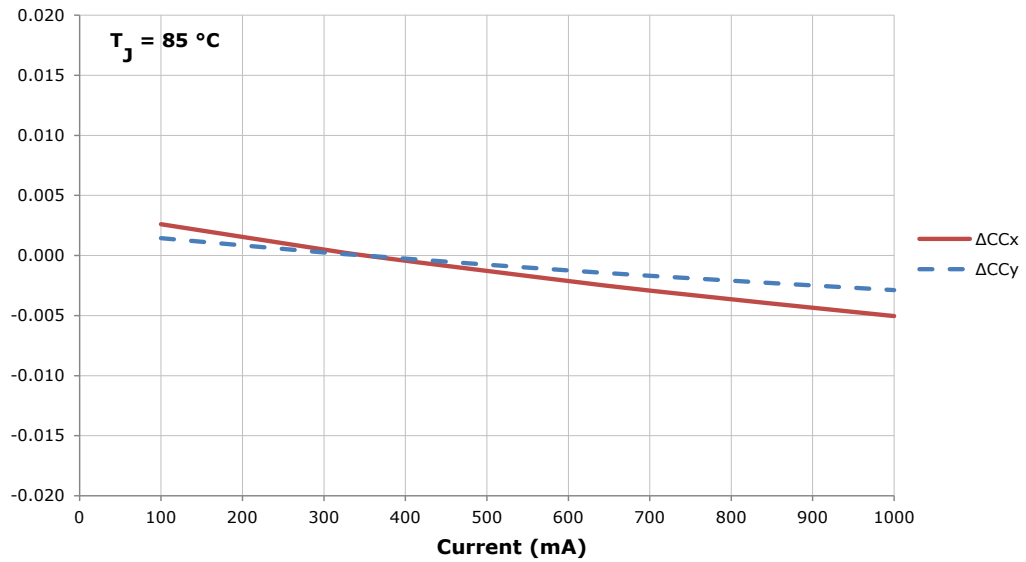
RELATIVE FLUX VS. CURRENT ($T_j = 85\text{ }^{\circ}\text{C}$) - WHITE



RELATIVE FLUX VS. CURRENT ($T_j = 25\text{ }^{\circ}\text{C}$) - COLOR

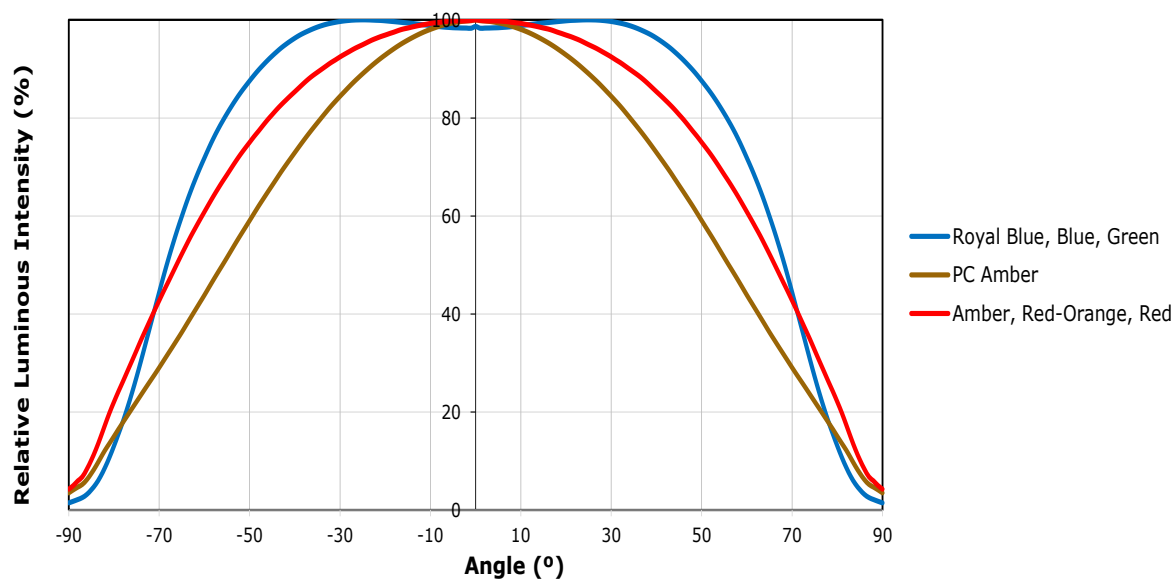
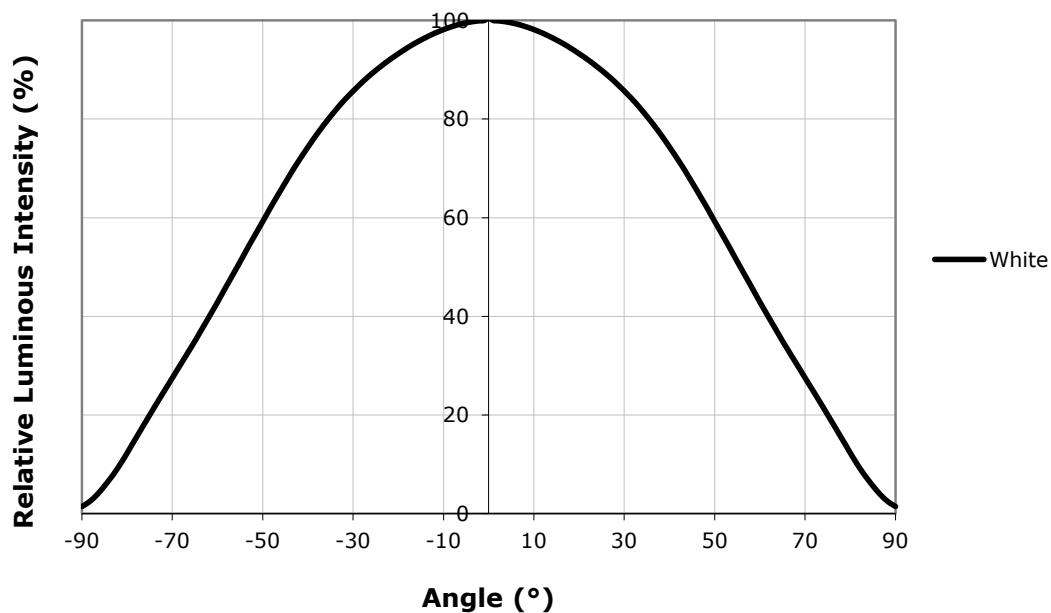


RELATIVE CHROMATICITY VS. CURRENT AND TEMPERATURE - WARM WHITE*



* Warm White XLamp XP-E2 LEDs have a typical CRI of 80.

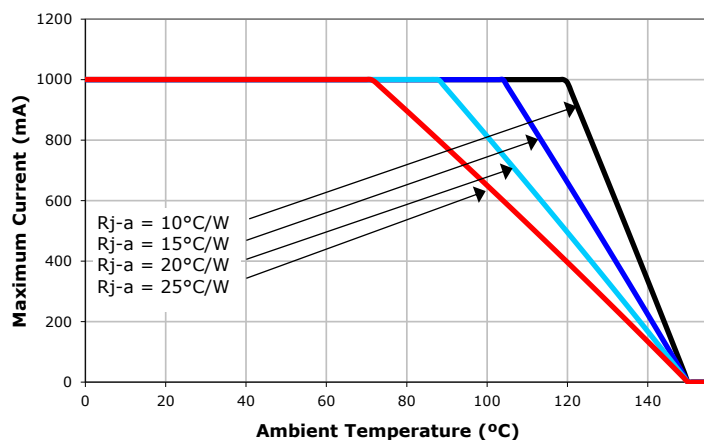
TYPICAL SPATIAL DISTRIBUTION



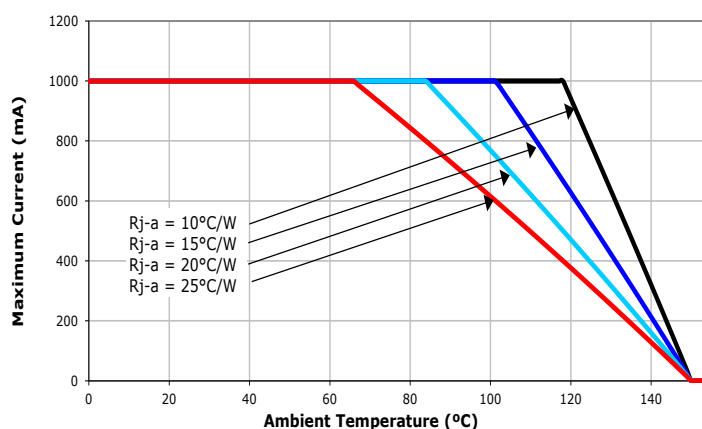
THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

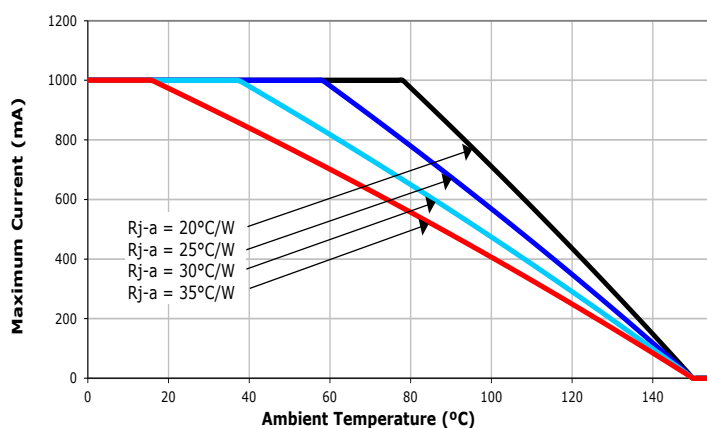
White



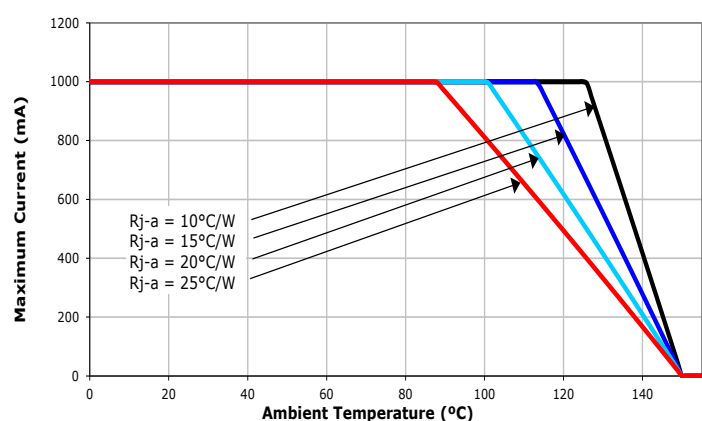
Royal Blue, Blue



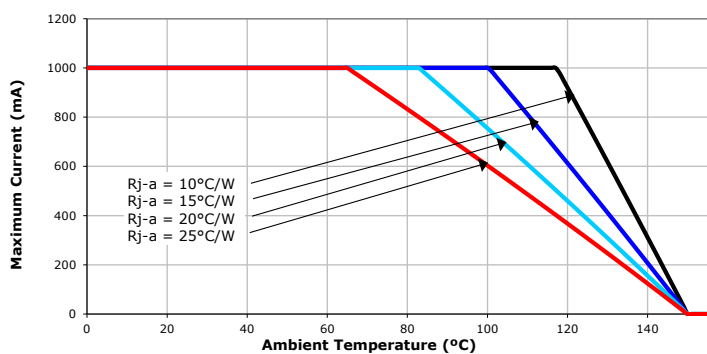
Green



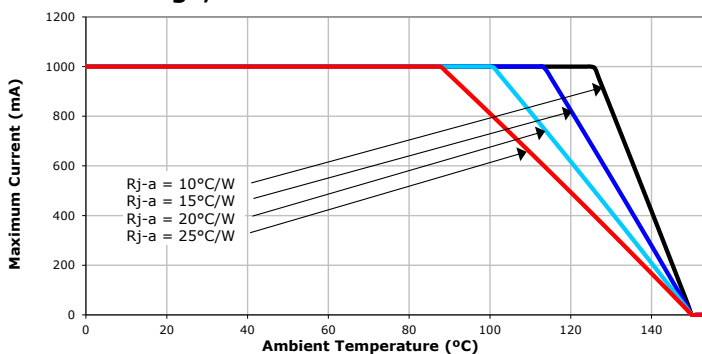
Amber



PC Amber



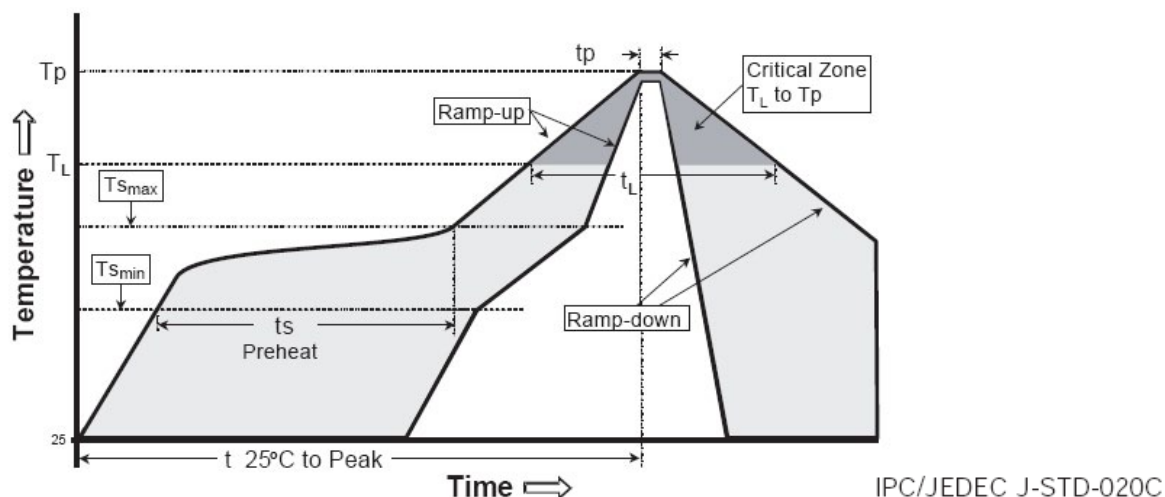
Red-Orange, Red



REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XP-E2 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (T_{Smax} to T_p)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (T_{Smin})	100 °C	150 °C
Preheat: Temperature Max (T_{Smax})	150 °C	200 °C
Preheat: Time (t_{Smin} to t_{Smax})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t_L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (T_p)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (t_p)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

NOTES

Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the [LM-80 results document](#).

Please read the [Long-Term Lumen Maintenance application note](#) for more details on Cree's lumen maintenance testing and forecasting. Please read the [Thermal Management application note](#) for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

In testing, Cree has found XLamp XP-E2 LEDs to have unlimited floor life in conditions $\leq 30\text{ }^{\circ}\text{C}/85\%$ relative humidity (RH). Moisture testing included a 168-hour soak at $85\text{ }^{\circ}\text{C}/85\%$ RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDs to the resealable moisture-barrier bag and closing the bag immediately after use.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

UL Recognized Component

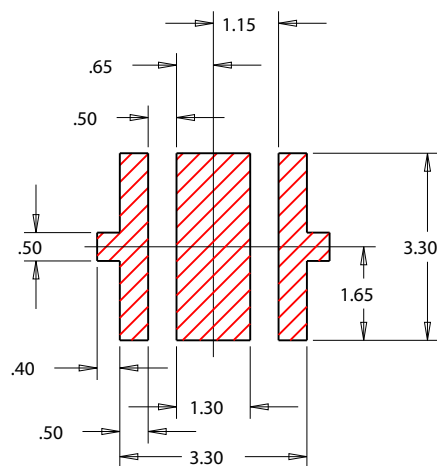
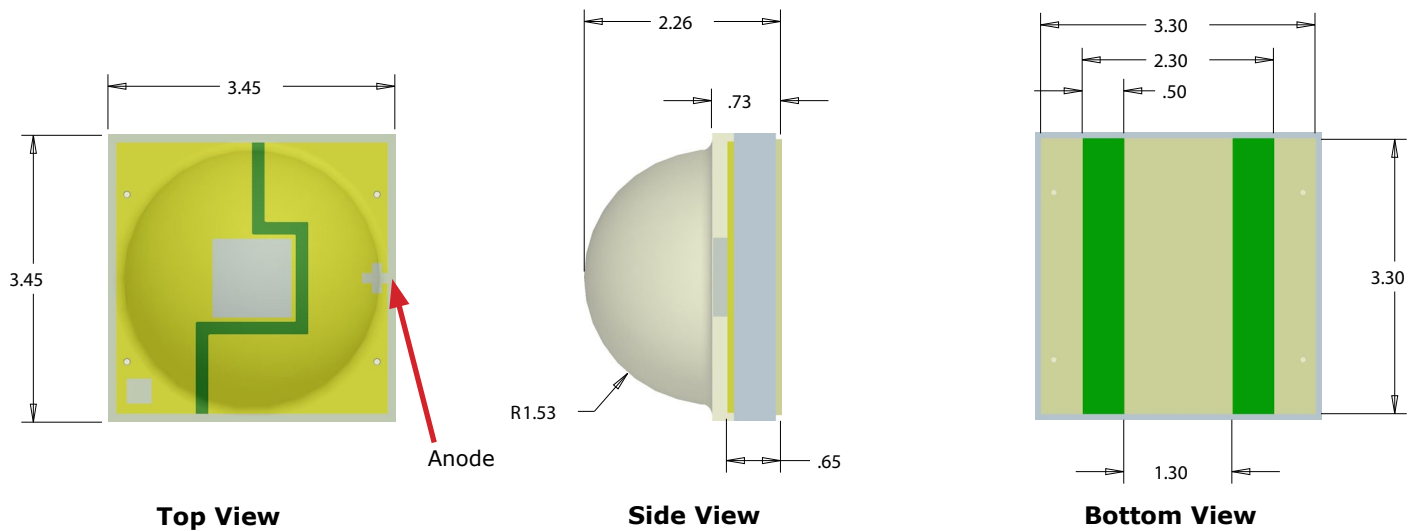
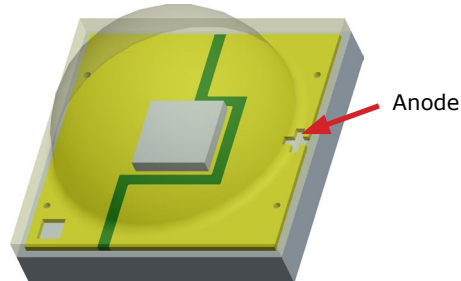
Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

Vision Advisory Claim

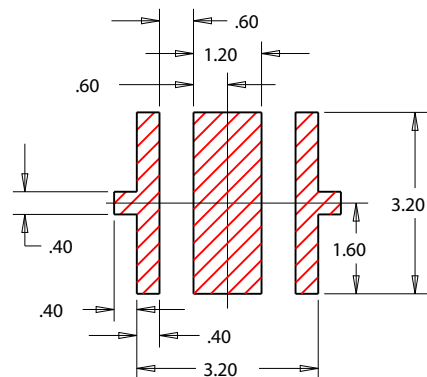
WARNING: Do not look at exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the [LED Eye Safety application note](#).

MECHANICAL DIMENSIONS

All measurements are ± 0.13 mm unless otherwise indicated.



Recommended PCB Solder Pad

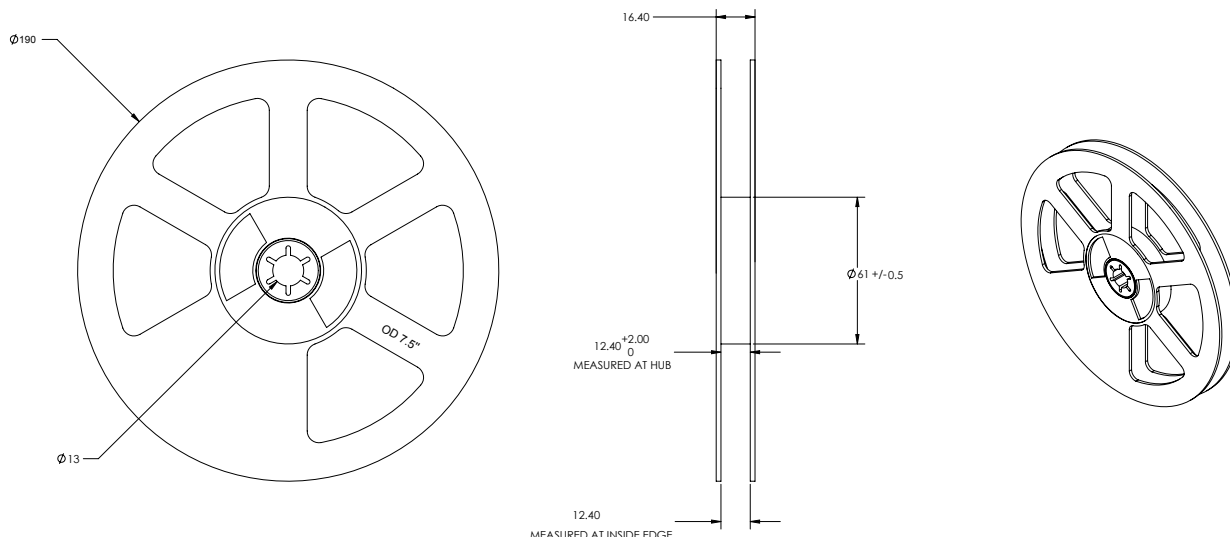
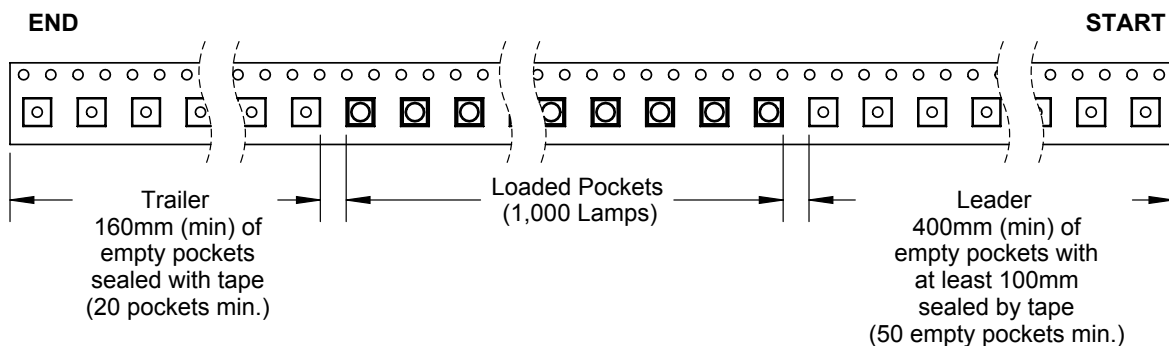
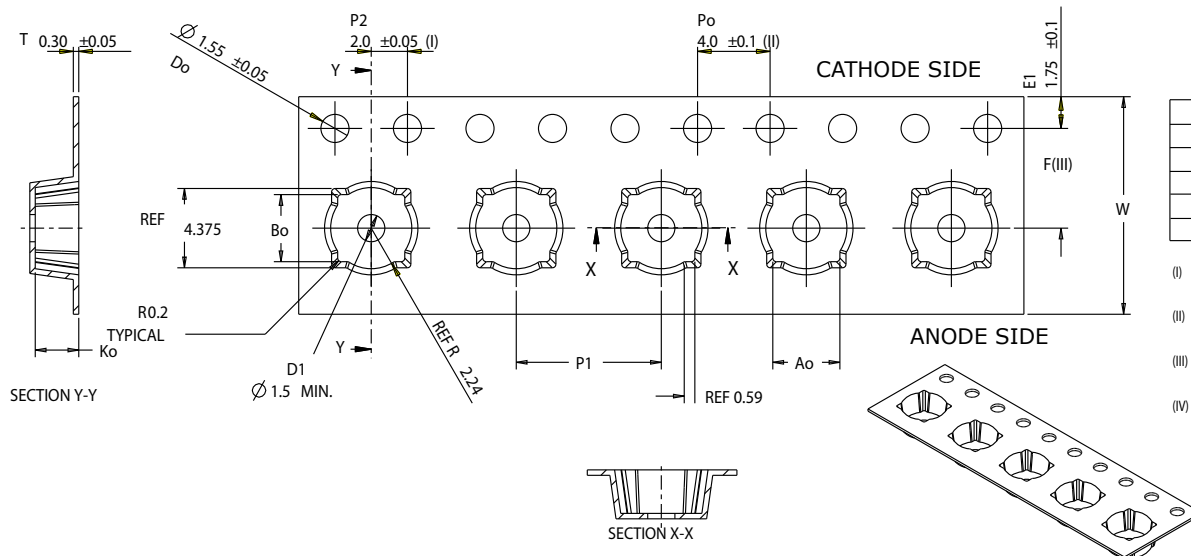


Recommended Stencil Pattern
Hatched Area is Opening

TAPE AND REEL

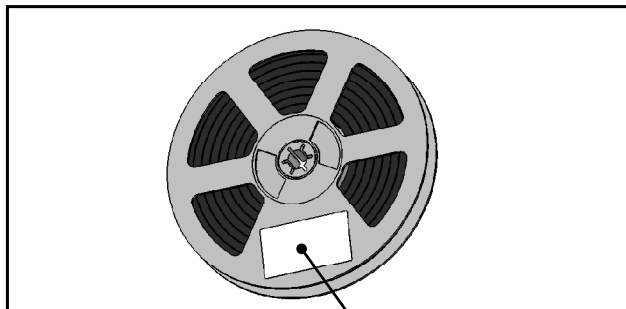
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.



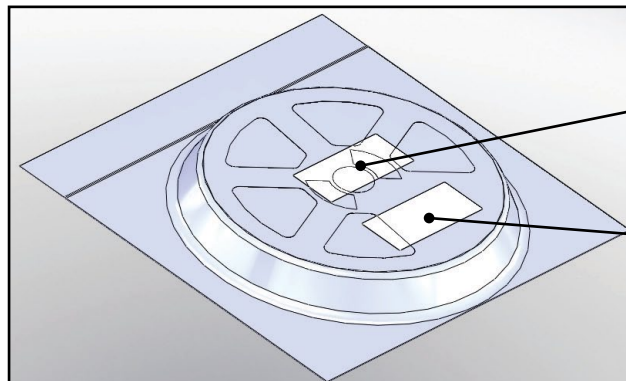
PACKAGING

Unpackaged Reel



Label with Cree Bin
Code, Qty, Reel ID

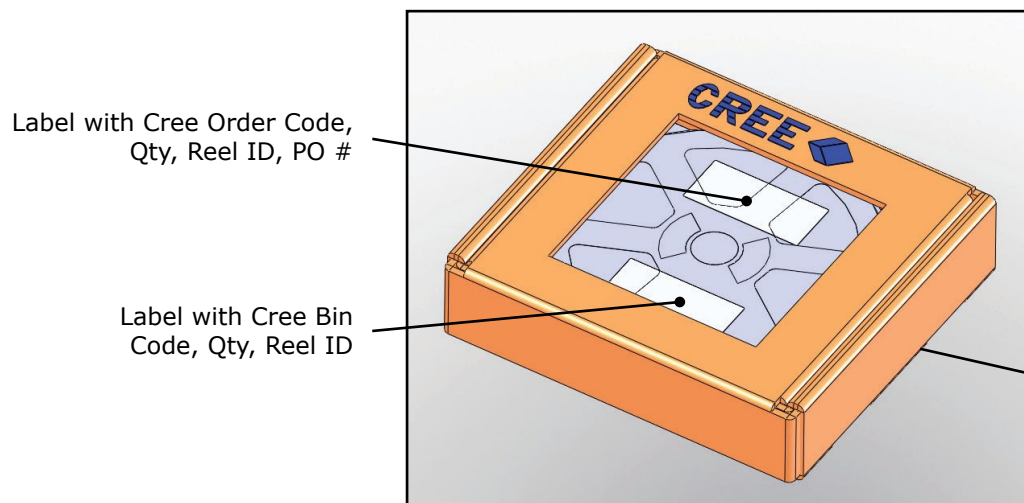
Packaged Reel



Label with Cree Order Code,
Qty, Reel ID, PO #

Label with Cree Bin
Code, Qty, Reel ID

Boxed Reel



Label with Cree Order Code,
Qty, Reel ID, PO #

Label with Cree Bin
Code, Qty, Reel ID

Patent Label
(on bottom of box)